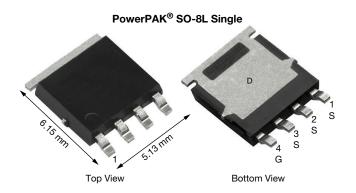


Automotive P-Channel 30 V (D-S) 175 °C MOSFET



PRODUCT SUMMARY	
V _{DS} (V)	-30
$R_{DS(on)}(\Omega)$ at $V_{GS} = -10 \text{ V}$	0.0085
$R_{DS(on)}(\Omega)$ at $V_{GS} = -4.5 \text{ V}$	0.0200
I _D (A)	-30 ^a
Configuration	Single

FEATURES

- TrenchFET® power MOSFET
- ESD protection: 3000 V
- AEC-Q101 qualified
- 100 % R_a and UIS tested
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>





COMPLIANT HALOGEN FREE

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	*	*	
G	•	5400 Ω	
		P-Channel	ļ

ORDERING INFORMATION	
Package	PowerPAK SO-8L
Lead (Pb)-free and halogen-free	SQJ403BEEP (for detailed order number please see www.vishay.com/doc?79771)

PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage		V _{DS}	-30	V	
Gate-source voltage		V _{GS}	± 20	V	
Continuous drain current a	T _C = 25 °C		-30		
Continuous drain current "	T _C = 125 °C	l _D	-30		
Continuous source current (diode conduction) a		I _S	-30	Α	
Pulsed drain current ^b		I _{DM}	-84		
Single pulse avalanche current	L = 10 mH	I _{AS}	-6.5		
Single pulse avalanche energy	L = 10 MH	E _{AS}	211	mJ	
Maximum power dissipation ^b	T _C = 25 °C	D	68	14/	
	T _C = 125 °C	P_{D}	22	W	
Operating junction and storage temperature range Soldering recommendations (peak temperature) d, e		T _J , T _{stg}	-55 to +175	°C	
			260	٠.	

THERMAL RESISTANCE RATINGS				
PARAMETER		SYMBOL	LIMIT	UNIT
Junction to ambient F	PCB mount c	R_{thJA}	68	°C/W
Junction to case (drain)		R_{thJC}	2.2	C/VV

Notes

- a. Package limited
- b. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2 %
- c. When mounted on 1" square PCB (FR4 material)
- d. See solder profile (www.vishay.com/doc?73257). The end of the lead terminal of PowerPAK SO-8L is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection
- e. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components



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PARAMETER	SYMBOL	TES	TEST CONDITIONS		TYP.	MAX.	UNIT
Static							
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} =	0 V, I _D = -250 μA	-30	-	-	V
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS} =	V _{GS} , I _D = -250 μA	-1.5	-2.0	-2.5	V
Gate-Source Leakage		V _{DS} =	0 V, V _{GS} = ± 12 V	-	-	± 2	μΑ
Gate-Source Leakage	I _{GSS}	V _{DS} =	$0 \text{ V}, \text{ V}_{GS} = \pm 20 \text{ V}$	-	-	± 1	mA
		$V_{GS} = 0 V$	$V_{DS} = -30 \text{ V}$	-	-	-1	
Zero Gate Voltage Drain Current	I _{DSS}	$V_{GS} = 0 V$	$V_{DS} = -30 \text{ V}, T_{J} = 125 ^{\circ}\text{C}$	-	i	-50	μΑ
		$V_{GS} = 0 V$	V _{DS} = -30 V, T _J = 175 °C	-	-	-250	
On-State Drain Current ^a	I _{D(on)}	$V_{GS} = -10 \text{ V}$	$V_{DS} \le -5 \text{ V}$	-30	-	-	Α
		$V_{GS} = -10 \text{ V}$	I _D = -10 A	-	0.0070	0.0085	
Drain-Source On-State Resistance ^a	B-ac	$V_{GS} = -10 \text{ V}$	$I_D = -10 \text{ A}, T_J = 125 ^{\circ}\text{C}$	-	-	0.0130	Ω
Drain-Source On-State Resistance 4	R _{DS(on)}	$V_{GS} = -10 \text{ V}$	I _D = -10 A, T _J = 175 °C	-	-	0.0150	52
		$V_{GS} = -4.5 \text{ V}$	I _D = -7 A	-	0.0120	0.0200	
Forward Transconductance b	9 _{fs}	V _{DS} =	: -10 V, I _D = -10 A	-	32	-	S
Dynamic ^b							
Output Capacitance	C _{oss}	$V_{GS} = 0 V$	V _{DS} = -15 V, f = 1 MHz	-	712	890	рF
Total Gate Charge c	Qg			-	75	164	
Gate-Source Charge c	Q _{gs}	V _{GS} = -10 V	$V_{DS} = -15 \text{ V}, I_{D} = -10 \text{ A}$	-	9.5	-	nC
Gate-Drain Charge ^c	Q _{gd}			-	19	-	
Gate Resistance	R_g		f = 1 MHz	2	4.3	7.5	kΩ
Turn-On Delay Time ^c	t _{d(on)}			-	38	57	
Rise Time ^c	t _r	V _{DD} =	-15 V, $R_L = 1.5 \Omega$	-	82	123	
Turn-Off Delay Time ^c	t _{d(off)}	$I_D \cong -10 \text{ A},$	$V_{GEN} = -10 \text{ V}, R_g = 1 \Omega$	-	134	201	ns
Fall Time ^c	t _f			-	178	214	
Source-Drain Diode Ratings and Chara	cteristics ^b						
Pulsed Current ^a	I _{SM}			-	-	-84	Α
Forward Voltage	V _{SD}	I _F = -3 A, V _{GS} = 0 V			-0.75	-1.2	V

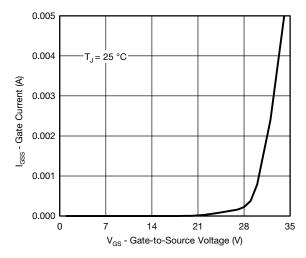
Notes

- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.
- c. Independent of operating temperature.

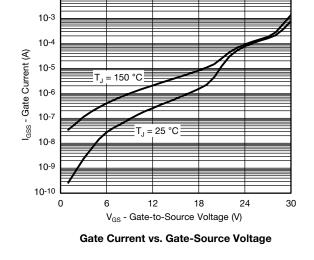
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



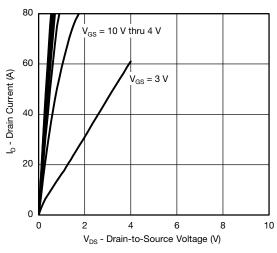
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



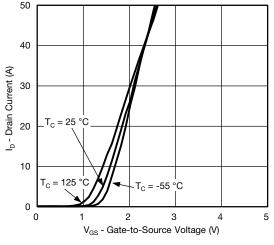
Gate Current vs. Gate-Source Voltage



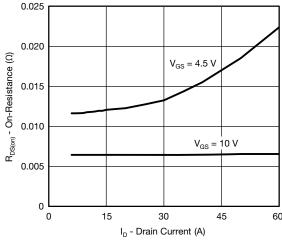
10-2



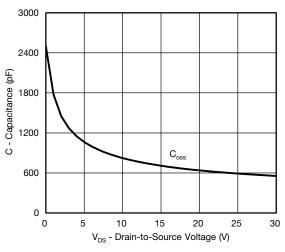
Output Characteristics



Transfer Characteristics



On-Resistance vs. Drain Current

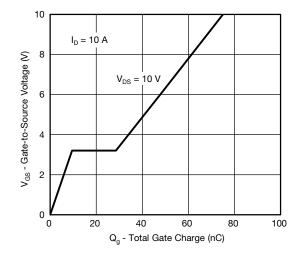


Capacitance

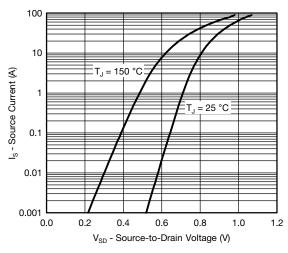
For technical questions, contact: automostechsu



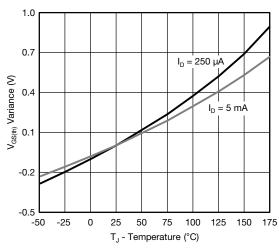
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



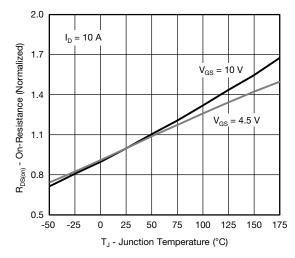
Gate Charge



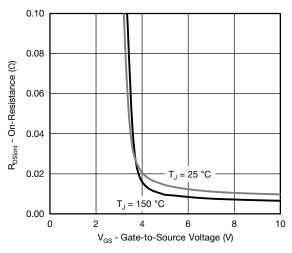
Source Drain Diode Forward Voltage



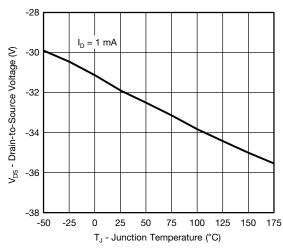
Threshold Voltage



On-Resistance vs. Junction Temperature



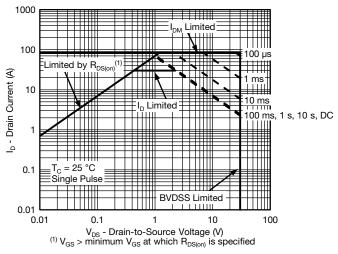
On-Resistance vs. Gate-to-Source Voltage



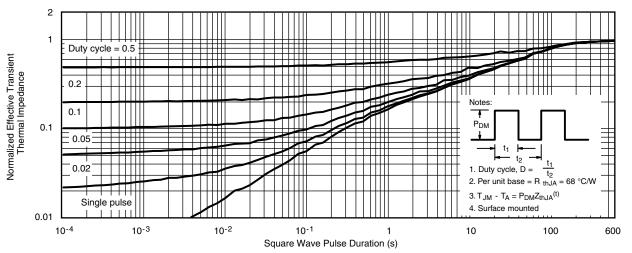
Drain Source Breakdown vs. Junction Temperature



THERMAL RATINGS (T_A = 25 °C, unless otherwise noted)



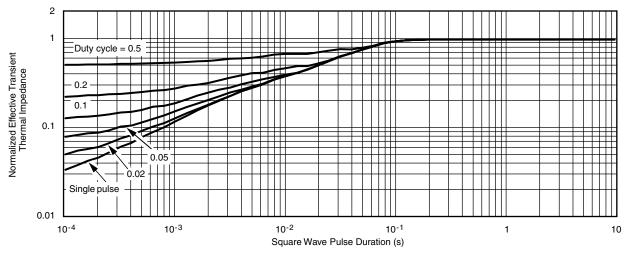
Safe Operating Area



Normalized Thermal Transient Impedance, Junction-to-Ambient



THERMAL RATINGS (T_A = 25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Case

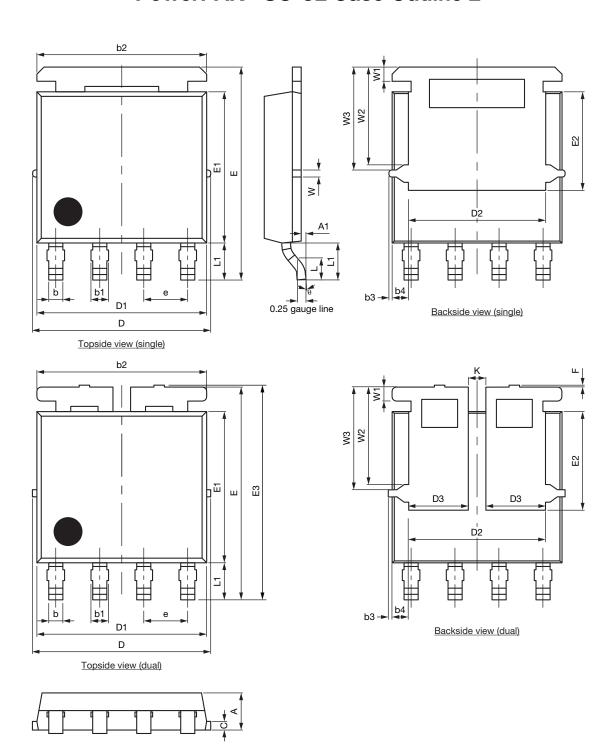
Note

- The characteristics shown in the two graphs
 - Normalized Transient Thermal Impedance Junction-to-Ambient (25 °C)
 - Normalized Transient Thermal Impedance Junction-to-Case (25 °C) are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions.

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg267407.



PowerPAK® SO-8L Case Outline 2





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DIM	MILLIMETERS			INCHES			
DIM.	MIN.	NOM.	MAX.	MIN.	NOM.	MAX	
Α	1.00	1.07	1.14	0.039	0.042	0.045	
A1	0.00	-	0.127	0.00	-	0.005	
b	0.33	0.41	0.48	0.013	0.016	0.019	
b1	0.44	0.51	0.58	0.017	0.020	0.023	
b2	4.80	4.90	5.00	0.189	0.193	0.197	
b3		0.094		0.004			
b4		0.47			0.019		
С	0.20	0.25	0.30	0.008	0.010	0.012	
D	5.00	5.13	5.25	0.197	0.202	0.207	
D1	4.80	4.90	5.00	0.189	0.193	0.197	
D2	3.86	3.96	4.06	0.152	0.156	0.160	
D3	1.63	1.73	1.83	0.064	0.068	0.072	
е		1.27 BSC		0.050 BSC			
Е	6.05	6.15	6.25	0.238	0.242	0.246	
E1	4.27	4.37	4.47	0.168	0.172	0.176	
E2	2.75	2.85	2.95	0.108	0.112	0.116	
E3	6.05	6.22	6.40	0.238	0.245	0.252	
F	-	-	0.15	-	-	0.006	
L	0.62	0.72	0.82	0.024	0.028	0.032	
L1	0.92	1.07	1.22	0.036	0.042	0.048	
K		0.51			0.020		
W		0.23			0.009		
W1		0.41			0.016		
W2	2.82		0.111				
W3		2.96			0.117		
θ	0°	-	10°	0°	-	10°	

DWG: 6044

Note

• Millimeters will govern



RECOMMENDED MINIMUM PAD FOR PowerPAK® SO-8L SINGLE



Recommended Minimum Pads Dimensions in mm (inches)



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